

IC for Multifunction Telephones

Monolithic IC LAG640

Outline

This IC was developed for use in multifunctional telephones with security features; it has the following functions.

Features

1. Incorporates efficient switching regulator with broad input voltage range

V_{OUT} 5V±0.25 I_L 250mA (13~45V)

V_{IN} 15~45V

2. Internal data transmission/reception circuits

Data can be superposed on the power supply line for transmission.

Can be switched between two different input modes

3. Internal system reset circuit

5V line abnormal voltage detection circuit

Watchdog timer reset circuit

4. Internal speaker amp

260 mW typ. at 8Ω load

Mute pin

5. Internal beep sound generator circuit

With pin to vary audio volume (also used to turn beep sound on and off)

Package

SDIP-30A (LAG640D)

Absolute Maximum Ratings (Ta=25°C)

| Item | Symbol | Ratings | Units |
|-----------------------|----------------------|----------|-------|
| Operating temperature | T _{OPR} | -20~+70 | °C |
| Storage temperature | T _{STG} | -40~+125 | °C |
| Power supply current | V _{CC} max. | 46 | V |
| Allowable loss | P _d | 750 | mW |

Electrical Characteristics (Except where noted otherwise, Ta=25°C, Vcc=30V)

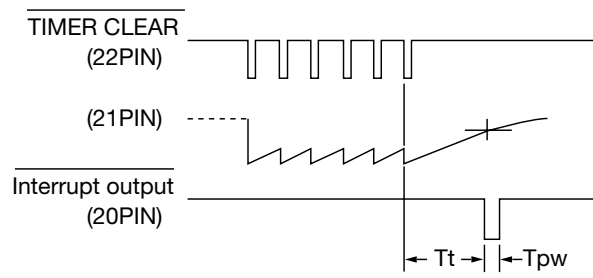
| Item | Symbol | Measurement circuit | Measurement conditions | Min. | Typ. | Max. | Units |
|--|-------------------|---------------------|--|------|------|------|-------------------|
| SWR unit | | | | | | | |
| Output voltage (5V) | V _{o1} | 1 | V _{CC} =15~45V I _L =0~250mA | 4.75 | 5.00 | 5.25 | V |
| Output voltage (5V) | V _{o2} | 1 | V _{CC} =13~45V I _L =0~200mA | 4.70 | 5.00 | 5.25 | V |
| Output ripple voltage | V _r | 1 | I _L =250mA | | | 50 | mV _{P-P} |
| Reactive current | I _{ccq} | 1 | I _L =0mA Amp & Transmission unit | | 6 | 10 | mA |
| SWR oscillation frequency | F _{OSC} | 1 | | | 80 | | kHz |
| Output current on short-circuit | I _{OS} | 1 | R _S =0.2Ω | 70 | 110 | 150 | mA |
| Power supply voltage detection unit | | | | | | | |
| Detection voltage | V _S | 2 | * | 4.30 | 4.50 | 4.80 | V |
| Detection drop voltage | ΔV _S | 2 | ΔV _S =V _o -V _S | 0.2 | | | V |
| Output current while on | I _{RON} | 2 | V _o =4V | 10 | 20 | | mA |
| Leakage output current while off | I _{ROFF} | 2 | V _o =5.25V | | | 1 | μA |

Note: The asterisk (*) indicates that the power supply voltage detection unit characteristics are standards in the transient power on/off states. However, for convenience the detection voltage is taken to be the value of V_o when V_o in measurement circuit 2 is varied and the pin 6 output state is switched from off to on.

Electrical Characteristics (Except where noted otherwise, Ta=25°C, Vcc=30V Faudio=1kHz)

| Item | Symbol | Measurement circuit | Measurement conditions | Min. | Typ. | Max. | Units |
|---|---------|---------------------|--|----------------|------|-------------|-------|
| Power amp unit | | | | | | | |
| Amp gain | Gv | 1 | Voa=0.775Vrms | 37 | 40 | 43 | dB |
| Maximum distortion-free output | Po max. | 1 | THD=10% | 150 | 260 | | mV |
| Distortion | THD | 1 | Po=100mW | | | 5 | % |
| Attenuation at 100 Hz | GF1/GF0 | 1 | Fo=1kHz, Fl=100Hz Voa=0.775Vrms | | -14 | | dB |
| Attenuation at 10 Hz | GF2/GF0 | 1 | F2=10 kHz, above conditions | | -8 | | dB |
| Input IMP 1 | RIN1 | 3 | Mute off | 10 | 15 | | kΩ |
| Input IMP 2 | RIN2 | 3 | Mute on | 2.5 | 3.5 | | kΩ |
| Residual noise 1 | Vno1 | 1 | Mute on AUDIO IN 20mVrms IL=10 70mA 1.5kHz Transmission unit on Ft=1kHz | | | 0.5 | mVrms |
| Residual noise 2 | Vno2 | 1 | Mute off AUDIO OFF IL=10 70mA 1.5kHz Transmission unit on Ft=1kHz | | | 1.2 | mVrms |
| Beep sound generator unit | | | | | | | |
| Beep sound frequency | Fb | 1 | | 0.85 | 1.0 | 1.15 | kHz |
| Beep off switching point | Ibsw | 1 | Pin 9 input current | 20 | 35 | 48 | μA |
| Beep sound output 1 | Vob1 | 1 | Pin 9 connected to GND through 4.7k Amp output voltage | 1.0 | 1.4 | 1.8 | Vrms |
| Beep sound output 2 | Vob2 | 1 | Pin 9 connected to GND through 47k | 0.11 | 0.16 | 0.22 | Vrms |
| Watchdog timer unit | | | | | | | |
| Timer time | Tt | 1 | cf. watchdog timer waveform diagram | 2.4 | 3.0 | 3.6 | S |
| Output pulse width | TPW | 1 | cf. watchdog timer waveform diagram T=beep sound period | 0.45 (1/2T) | | 1.1 (1T) | mS |
| Output voltage while on | VWON | 1 | | | | 0.5 | V |
| Leakage output current while off | IWOFF | 1 | | | | 1 | μA |
| Timer-clearing pulse width | Tcl | 1 | | 5 | | | μS |
| Transmission circuit unit | | | | | | | |
| Transmission output voltage (1) | Vto1 | 2 | RL=110Ω, peak value across pins L3-L4 | 5.1 | 5.8 | 6.6 | Vp-p |
| Transmission output voltage (2) | Vto2 | 2 | RL=1Ω, peak value across pins L3-L4 | 5.5 | 6.2 | 7.0 | Vp-p |
| L3 pin voltage | VL3 | 2 | No signal | 4.0 | 4.4 | 4.8 | V |
| L4 pin voltage | VL4 | 2 | No signal | 0.5 | 0.7 | 0.9 | V |
| Reception sensitivity | Vrs | 2 | | 0.8 | 1.0 | 1.2 | Vp-p |
| Input IMP | RIN3 | 4 | Both pins 7and 8 | 14 | 20 | 26 | kΩ |
| Transmission delay time | Td1 | 2 | cf. transmit/receive waveform diagrams | | 0.4 | | μS |
| Transmission delay time | Td2 | 2 | cf. transmit/receive waveform diagrams | | 0.4 | | μS |
| Transmission delay time | Td3 | 2 | cf. transmit/receive waveform diagrams | | 0.8 | | μS |
| Transmission delay time | Td4 | 2 | cf. transmit/receive waveform diagrams | | 0.8 | | μS |
| Reception output H voltage | VroH | 2 | RL=10kΩ | 4.5 | | | V |
| Reception output L voltage | VroL | 2 | RL=1.5kΩ | | | 0.5 | V |
| General logic unit characteristics | | | | | | | |
| H level input voltage | VIH | 3 | | 2.4 | | | V |
| L level input voltage | ViL | 3 | | | | 0.8 | V |
| H level input current | IiH | 3 | VIN=2.4V | | | 10 | μA |
| L level input current | IiL | 3 | VIN=0.4V | | | -300 | μA |

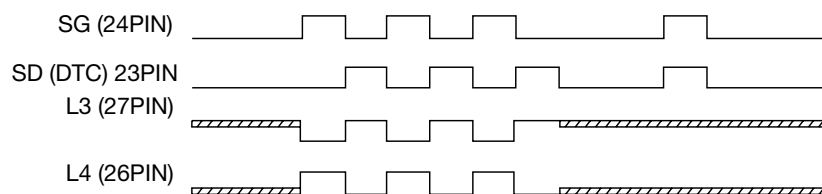
Watchdog Timer Waveform Diagrams



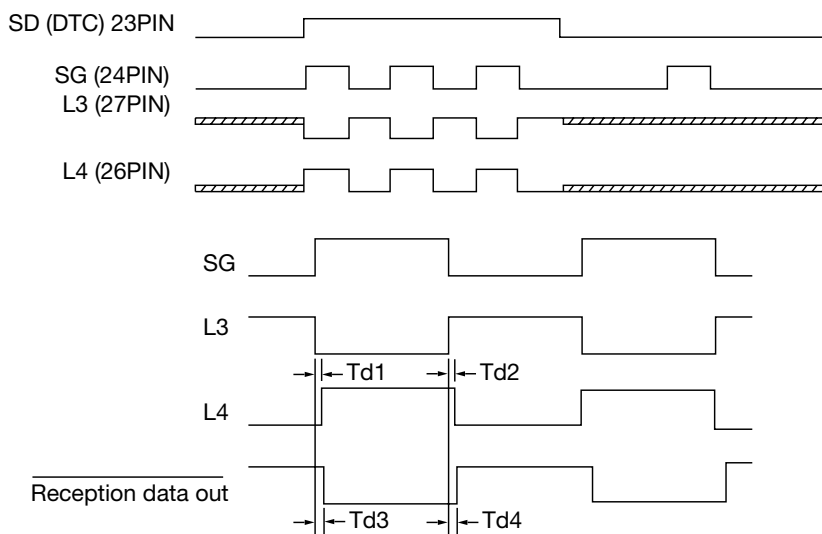
Note: Pulses to clear the timer must have a width of $5\mu s$ or more.

Transmit/receive Waveform

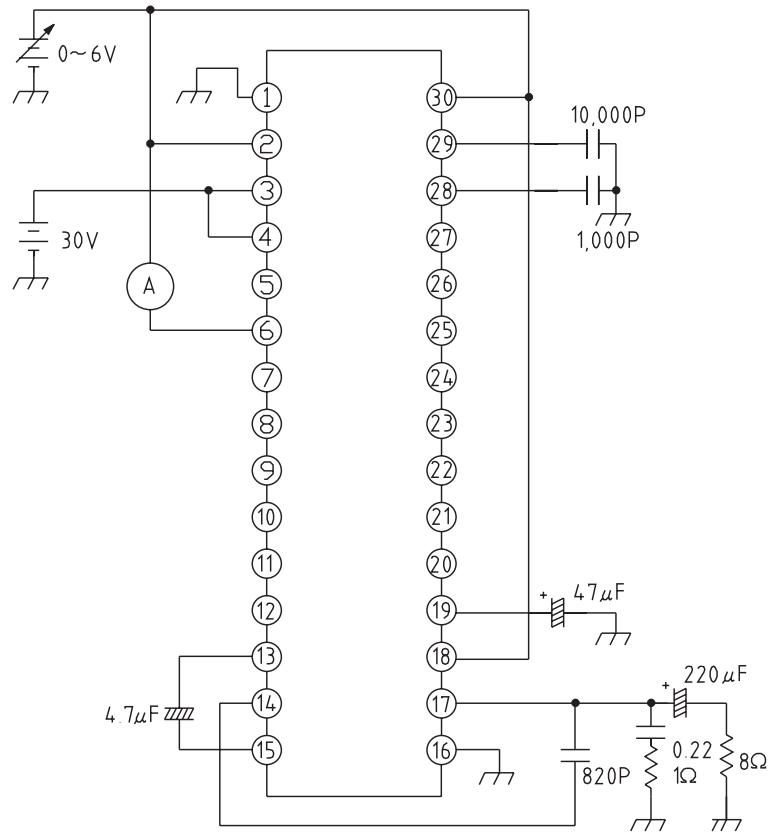
1. When pulling pin 25 up to V_{DD} (+5V)



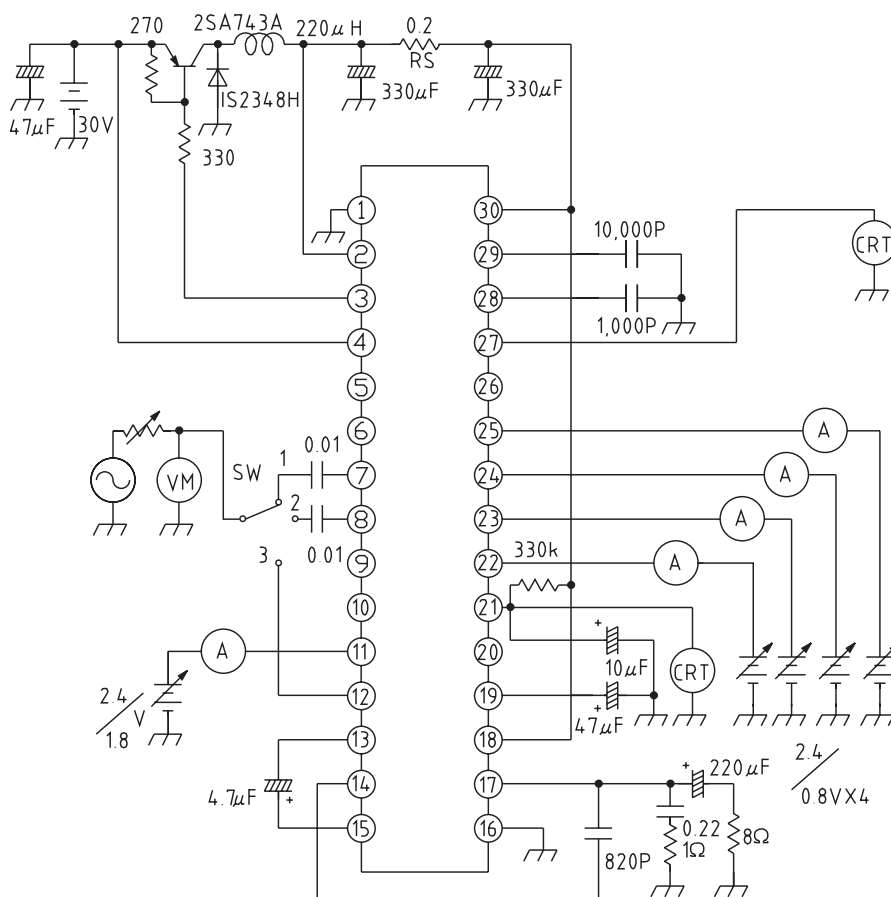
2. When shorting pin 25 to GND



■ Measurement circuit 3



■ Measurement circuit 4



Switch Operation (Measurement circuit 1)

| Measurement item | SW1 | SW2 | SW3 | SW4 | Other Conditions |
|--------------------------------------|-----|--------|-----|-----|---|
| Vo1, Vo2 | ○ | × | ○ | 1 | |
| Vr | ○ | × | ○ | 1 | No spike noise |
| Iccq | ○ | × | ○ | 1 | A1 only |
| Ios | ○ | × | ○ | 1 | A2 only |
| Gv, Po max., THD GF1/GF0, GF2/GF0 | × | × | ○ | 1 | THD measured after passing through 400Hz-15kHz BPF |
| Vno1 | ○ | × | ○ | 2 | Using 400Hz-15kHz BPF |
| Vno2 | × | × | ○ | 2 | Using 400Hz-15kHz BPF |
| Fb, IbSW, Vob1, Vob2 | ○ | × | ○ | 1 | |
| Tt, TPW, Vwon, Tcl | — | × | ○ | 1 | cf. watchdog timer waveform diagram |
| | | ↓ ○ | | | |
| IWOFF | — | × | × | 1 | |

Switch Operation (Measurement circuit 2)

| Measurement | SW1 | SW2 | SW3 | SW4 | SW5 | SW6 | SW7 | |
|-------------|-----|-----|-----|-----|-----|-----|-----|---|
| Vto1 | 1 | 1 | — | ○ | × | × | × | Peak value across pins L3, L4 |
| | 2 | 2 | — | ○ | × | × | × | Peak value across pins L3, L4 |
| Vto2 | 1 | 1 | — | × | ○ | × | × | Peak value across pins L3, L4 |
| | 2 | 2 | — | × | ○ | × | × | Peak value across pins L3, L4 |
| VL3 | 2 | 3 | 1 | × | × | × | × | |
| VL4 | 2 | 3 | 2 | × | × | × | × | |
| Vrs | 2 | 2 | — | ○ | × | ○ | ○ | Measured with Rt adjusted |
| Td1~Td4 | 2 | 2 | — | ○ | × | ○ | ○ | cf. transmit/receive waveform diagrams |
| VroH, VroL | 2 | 2 | — | ○ | × | ○ | ○ | |

Notes on Use

1. Protection from high-frequency noise

In consideration of applications in which telephone sets are connected over long distances, this IC is designed for high withstand and static breakdown voltages at pins 3 and 4, which are in danger of being exposed to electrostatic charge and high-frequency noise.

| | | |
|--------------|--|------------------|
| Pins 3 and 4 | DC withstand voltage | 46V or higher |
| | Static breakdown voltage (human body buildup method, 200pF, 0Ω) | ±1000V or higher |
| Other pins | DC withstand voltage | 15V or higher |
| | Static breakdown voltage (human body buildup method, 200pF, 0Ω) | ±300V or higher |

However, the IC may be damaged by adverse mounting or use conditions, and so it is recommended that a surge suppressor be inserted between pin 4 and GND.

2. Protection from surge currents

A diode for capacitor charging is connected between data transmission output pins 26 and 27 as shown below; the surge current ratings shown below should not be exceeded.

If these ratings are to be exceeded, it is recommended that a resistance R for surge current limiting or a diode Dt for absorption be inserted.

| | | |
|--------------------------------|------------|-------|
| Internal diode maximum ratings | Io | 100mA |
| | IF (peak) | 500mA |
| | IF (surge) | 700mA |

